Single buffer Rev. 6 — 13 November 2024

1. General description

The 74LVC1G34-Q100 is a single buffer. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments.

Schmitt-trigger action at all inputs makes the circuit tolerant of slower input rise and fall times.

This device is fully specified for partial power down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Wide supply voltage range from 1.65 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- ±24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power dissipation
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- I_{OFF} circuitry provides partial Power-down mode operation
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC1G34GW-Q100	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	<u>SOT353-1</u>
74LVC1G34GV-Q100	-40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	<u>SOT753</u>
74LVC1G34GZ-Q100	-40 °C to +125 °C	XSON5	plastic thermal enhanced extremely thin small outline package with side-wettable flanks (SWF); no leads; 5 terminals; body 1.1 × 0.85 × 0.5 mm	<u>SOT8065-1</u>

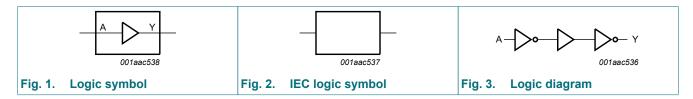


4. Marking

Table 2. Marking		
Type number	Marking code[1]	
74LVC1G34GW-Q100	YN	
74LVC1G34GV-Q100	YN	
74LVC1G34GZ-Q100	YN	

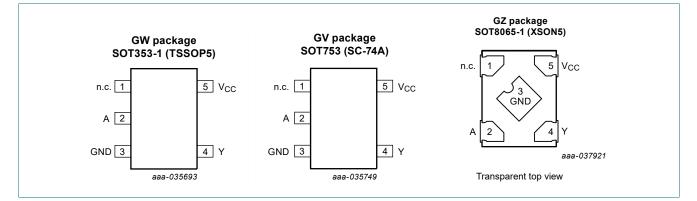
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



6. Pinning information

6.1. Pinning



6.2. Pin description

Table 3. Pin description				
Symbol	Pin	Description		
n.c.	1	not connected		
A	2	data input		
GND	3	ground (0 V)		
Y	4	data output		
V _{CC}	5	supply voltage		

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level.

Input	Output
A	Y
L	L
Н	Н

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage	[1]	-0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	Active mode [1]	-0.5	V _{CC} + 0.5	V
		Power-down mode; $V_{CC} = 0 V$ [1]	-0.5	+6.5	V
I _O	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C [2]	-	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT353-1 (TSSOP5) package: Ptot derates linearly with 3.3 mW/K above 74 °C.

For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C.

For SOT8065-1 (XSON5) package: Ptot derates linearly with 3.2 mW/K above 72 °C.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	Active mode	0	-	V _{CC}	Vo
		Power-down mode; V_{CC} = 0 V	0	-	5.5	Vo
T _{amb}	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	-	-	20	ns/V
		V_{CC} = 2.7 V to 5.5 V	-	-	10	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -4	0 °C to +85 °C	·				
V _{IH}	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7 × V _{CC}	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3 × V _{CC}	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}				
		I_{O} = -100 µA; V_{CC} = 1.65 V to 5.5 V	V _{CC} - 0.1	-	-	V
		I _O = -4 mA; V _{CC} = 1.65 V	1.2	1.54	-	V
		I _O = -8 mA; V _{CC} = 2.3 V	1.9	2.15	-	V
		I _O = -12 mA; V _{CC} = 2.7 V	2.2	2.50	-	V
		I _O = -24 mA; V _{CC} = 3.0 V	2.3	2.62	-	V
		I _O = -32 mA; V _{CC} = 4.5 V	3.8	4.11	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = 100 µA; V_{CC} = 1.65 V to 5.5 V	-	-	0.10	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	0.07	0.45	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	0.12	0.30	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	0.17	0.40	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	0.33	0.55	V
		I _O = 32 mA; V _{CC} = 4.5 V	-	0.39	0.55	V
lı –	input leakage current	$V_{CC} = 0 V \text{ to } 5.5 V; V_I = 5.5 V \text{ or GND}$ [2]	-	±0.1	±1	μA
I _{OFF}	power-off leakage current	V _{CC} = 0 V; V _I or V _O = 5.5 V	-	±0.1	±2	μA
I _{CC}	supply current	$V_{CC} = 1.65 \text{ V to } 5.5 \text{ V; } I_{O} = 0 \text{ A;}$ [2] V _I = 5.5 V or GND	-	0.1	4	μA
ΔI _{CC}	additional supply current	$V_{CC} = 2.3 \text{ V to } 5.5 \text{ V}; \text{ V}_{I} = V_{CC} - 0.6 \text{ V};$ [2] $I_{O} = 0 \text{ A}$	-	5	500	μA
CI	input capacitance	V_{CC} = 3.3 V; V_{I} = GND to V_{CC}	-	4	-	pF

Single buffer

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = -4	0 °C to +125 °C	1			1	
VIH	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}	-	-	V
		V _{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	V
		V _{CC} = 4.5 V to 5.5 V	0.7 × V _{CC}	-	-	V
V _{IL} LO	LOW-level input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V _{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	V
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3 × V _{CC}	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = -100 µA; V_{CC} = 1.65 V to 5.5 V	V _{CC} - 0.1	-	-	V
		I _O = -4 mA; V _{CC} = 1.65 V	0.95	-	-	V
		I _O = -8 mA; V _{CC} = 2.3 V	1.7	-	-	V
		I _O = -12 mA; V _{CC} = 2.7 V	1.9	-	-	V
		I _O = -24 mA; V _{CC} = 3.0 V	2.0	-	-	V
		I _O = -32 mA; V _{CC} = 4.5 V	3.4	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = 100 µA; V_{CC} = 1.65 V to 5.5 V	-	-	0.10	V
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.70	V
		I _O = 8 mA; V _{CC} = 2.3 V	-	-	0.45	V
		I _O = 12 mA; V _{CC} = 2.7 V	-	-	0.60	V
		I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.80	V
		I _O = 32 mA; V _{CC} = 4.5 V	-	-	0.80	V
l _l	input leakage current	V_{CC} = 0 V to 5.5 V; V _I = 5.5 V or GND	-	-	±1	μA
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	-	±2	μA
I _{CC}	supply current	V _{CC} = 1.65 V to 5.5 V; I _O = 0 A; V _I = 5.5 V or GND	-	-	4	μA
ΔI _{CC}	additional supply current	V_{CC} = 2.3 V to 5.5 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	-	500	μA

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 5.

Symbol	Parameter	Conditions	-40	°C to +85	5 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	A to Y; see <u>Fig. 4</u> [2]						
		V _{CC} = 1.65 V to 1.95 V	1.0	4.0	8.6	1.0	11.0	ns
		V_{CC} = 2.3 V to 2.7 V	0.5	2.6	4.4	0.5	5.6	ns
		V _{CC} = 2.7 V	0.5	2.3	4.5	0.5	5.6	ns
		V _{CC} = 3.0 V to 3.6 V	0.5	2.0	4.1	0.5	5.2	ns
		V_{CC} = 4.5 V to 5.5 V	0.5	1.6	3.2	0.5	4.1	ns
C _{PD}	power dissipation capacitance	$V_1 = GND \text{ to } V_{CC}; V_{CC} = 3.3 \text{ V} [3]$	-	15	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V, and 5.0 V respectively.

[2]

 t_{pd} is the same as t_{PLH} and t_{PHL} . C_{PD} is used to determine the dynamic power dissipation (P_D in µW). [3]

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output$ frequency in MHz;

 C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

11.1. Waveform and test circuit

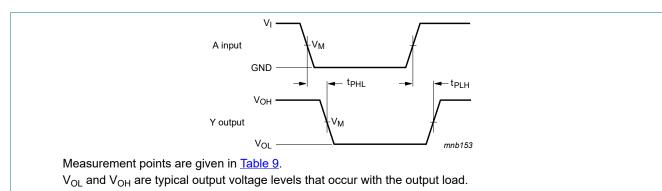
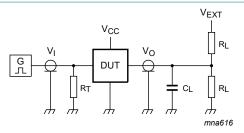


Fig. 4. The data input (A) to output (Y) propagation delays

Table 9. Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	V _M
1.65 V to 1.95 V	0.5 x V _{CC}	0.5 x V _{CC}
2.3 V to 2.7 V	0.5 x V _{CC}	0.5 x V _{CC}
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	0.5 x V _{CC}	0.5 x V _{CC}

Single buffer



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance;

 C_L = Load capacitance including jig and probe capacitance;

 R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator;

 V_{EXT} = External voltage for measuring switching times.

Fig. 5. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Input		Load	V _{EXT}	
V _{cc}	VI	t _r = t _f	CL	RL	t _{PLH} , t _{PHL}
1.65 V to 1.95 V	V _{CC}	≤ 2.0 ns	30 pF	1 kΩ	open
2.3 V to 2.7 V	V _{CC}	≤ 2.0 ns	30 pF	500 Ω	open
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
4.5 V to 5.5 V	V _{CC}	≤ 2.5 ns	50 pF	500 Ω	open

Single buffer

12. Package outline

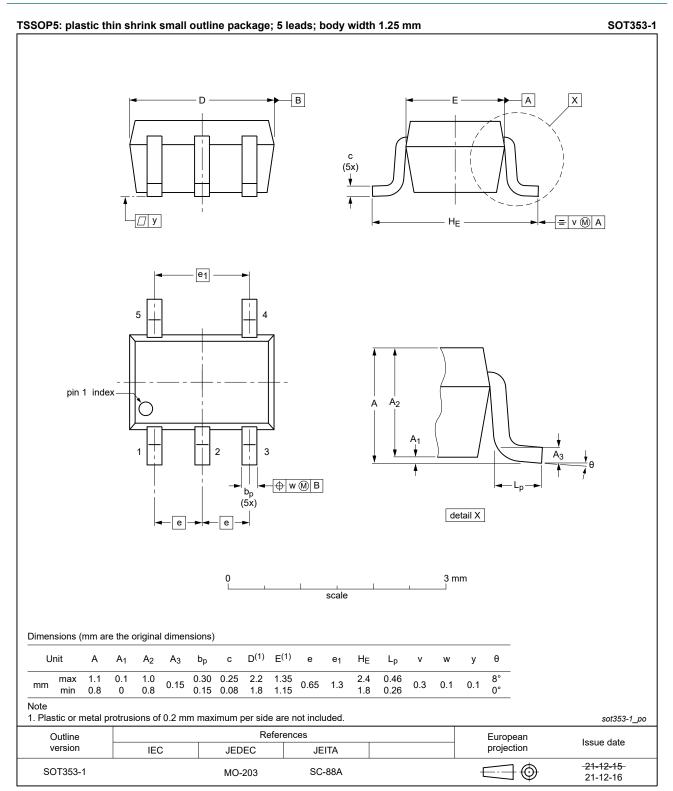


Fig. 6. Package outline SOT353-1 (TSSOP5)

74LVC1G34_Q100

Single buffer



SOT753

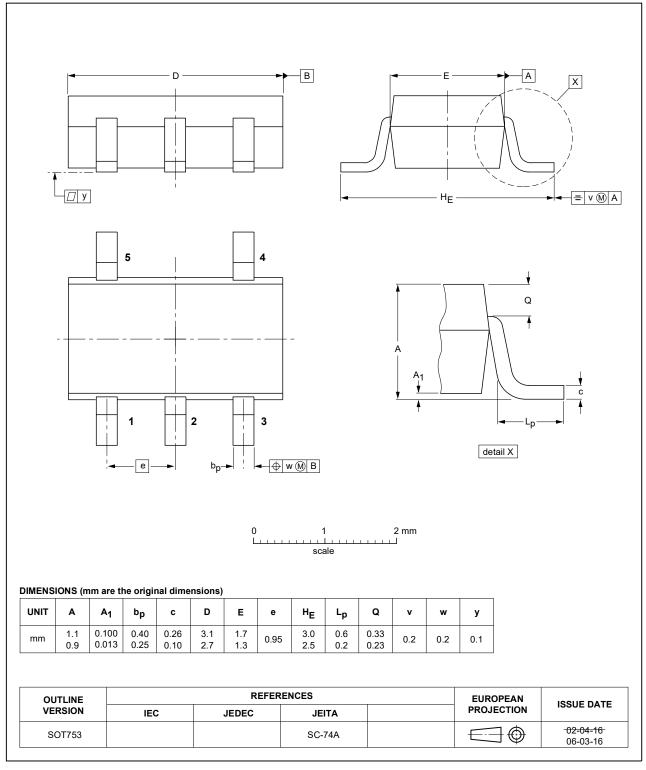
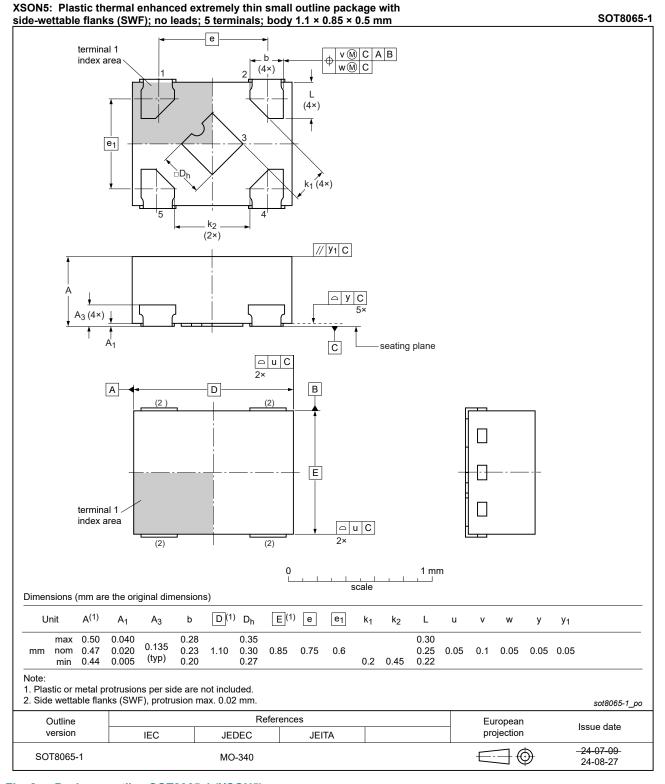


Fig. 7. Package outline SOT753 (SC-74A)

Single buffer





13. Abbreviations

Table 11. Abbreviations			
Acronym	Description		
ANSI	American National Standards Institute		
CMOS	Complementary Metal-Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
ESDA	ElectroStatic Discharge Association		
НВМ	Human Body Model		
JEDEC	Joint Electron Device Engineering Council		
TTL	Transistor-Transistor Logic		

14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC1G34_Q100 v.6	20241113	Product data sheet	-	74LVC1G34_Q100 v.5	
Modifications:	Type number 74LVC1G34GZ-Q100 (SOT8065-1/XSON5) added.				
74LVC1G34_Q100 v.5	20230824	Product data sheet	-	74LVC1G34_Q100 v.4	
Modifications:	<u>Section 2</u> : ESD specification updated according to the latest JEDEC standard.				
74LVC1G34_Q100 v.4	20220117	Product data sheet	-	74LVC1G34_Q100 v.3	
Modifications:	• Fig. 6: Package outline drawing SOT353-1 (TSSOP5) has changed.				
74LVC1G34_Q100 v.3	20210927	Product data sheet	-	74LVC1G34_Q100 v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. <u>Section 1</u> and <u>Section 2</u> updated <u>Table 5</u>: Derating values for P_{tot} total power dissipation updated. 				
74LVC1G34_Q100 v.2	20161209	Product data sheet	-	74LVC1G34_Q100 v.1	
Modifications:	• <u>Table 7</u> : The maximum limits for leakage current and supply current have changed.				
74LVC1G34 Q100 v.1	20121001	Product data sheet	-	-	

Single buffer

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Single buffer

Contents

1. General description	1
2. Features and benefits	1
3. Ordering information	1
4. Marking	2
5. Functional diagram	2
6. Pinning information	2
6.1. Pinning	2
6.2. Pin description	2
7. Functional description	3
8. Limiting values	3
9. Recommended operating conditions	3
10. Static characteristics	4
11. Dynamic characteristics	6
11.1. Waveform and test circuit	6
12. Package outline	8
13. Abbreviations	11
14. Revision history	11
15. Legal information	12

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